

ADH361S

1.0 SCOPE

This specification documents the detail requirements for an internally defined equivalent flow per MIL-PRF-38535 Level V except as modified herein.

The manufacturing flow described in the RF & MICROWAVE STANDARD SPACE LEVEL PRODUCTS PROGRAM is to be considered a part of this specification.

This data specifically details the space grade version of this product. A more detailed operational description and a complete data sheet for commercial product grades can be found at http://www.analog.com/HMC361G8

2.0 Part Number

The complete part number(s) of this specification follows:

Specific Part Number Description

ADH361R701G8 DC to 12 GHz Divide-by-2

3.0 Case Outline

The case outline is as follows:

| Outline Letter | Descriptive Designator | <u>Terminals</u> | <u>Lead Finish</u> | Package style |
|----------------|------------------------|------------------|--------------------|-------------------------------|
| Χ | FR-8-2 | 8 Lead | Gold | Glass/Metal Hermetic SMT (G8) |

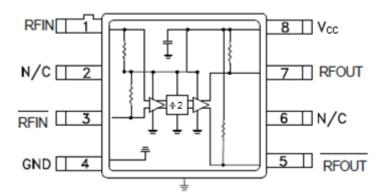


Figure 1 - Functional Block Diagram

| Package: X | | | | |
|-------------------|--------------------|-----------|--|------------------------|
| Pin Number | Terminal Symbol | Pin Type | Pin Description | Interface Schematic |
| 1 | RFIN | RF Input | Positive RF differential Input <u>1</u> / | Vcc 05V 50Ω RFIN |
| 2 | N/C | | No Connection | |
| 3 | RFIN | RF Input | Negative RF differential Input <u>2</u> / | Vcc ο RFIN |
| 4 | GND | Power | RF/DC ground | GND |
| 5 | RFOUT | RF Output | Negative RF differential Output <u>3</u> / | Vcc 05V RFOUT |
| 6 | N/C | N/C | No Connection | |
| 7 | RFOUT | RF Output | Positive RF differential Output <u>4</u> / | Vcc 05V |
| 8 | Vcc | Power | Supply Voltage <u>5</u> / | 5V 25 \$50 |
| Package Bottom | GND | Power | RF/DC ground <u>6</u> / | GND |
| Package Lid | | NIC | 7/ | |

Figure 2 – Terminal Connections

- 1/ RF Input must be DC blocked.
 2/ RF Input 180° out of phase with pin 1 for differential operation. Must be DC blocked. AC ground for single ended operation.
 3/ Divided output 180° out of phase with pin 7. Must be DC blocked.
 4/ RF Divided Output must be DC blocked.
 5/ Supply voltage 4.75 V to 5.25 V
 6/ Package bottom must be connected to RF/DC ground.
 7/ No internal connection on lid. Lid may be connected to RF/DC ground.

4.0 Specifications

| 4.1. <u>Absolute Maximum Ratings</u> <u>1</u> / | |
|--|------------------------|
| Supply voltage (Vcc) | 5.5 Vdc |
| RF Input (Vcc = +5 V) | +13 dBm |
| Junction temperature maximum (T _J) | +135 °C |
| Continuous PDiss (T= 85 °C) | 534 mW |
| (derate 10.7 mW/°C above 85 °C) | |
| Thermal resistance, junction-to-case $(\theta \slash c)$ | 92 °C/W |
| Thermal resistance, junction-to-ambient (θ_{JA}) | 96 °C/W |
| Storage temperature range | -65 °C to +150 °C |
| 4.2. Recommended Operating Conditions | |
| Supply voltage (Vcc) | +4.75 V to +5.25 V |
| Ambient operating temperature range (T _A) | 40 °C to +85 °C |
| 4.3. Nominal Operating Performance Characteristics 2/ | |
| Input Sensitivity near DC Operation (Square Wave input) | |
| 0.01 to 0.2 GHz | -10 dBm to +10 dBm |
| Input Sensitivity near DC Operation (Sine Wave input) | |
| 0.2 to 0.5 GHz | 0 dBm to +10 dBm |
| 0.5 to 1 GHz | -10 dBm to +10 dBm |
| Output Transition Time ($F_{OUT} = 882 \text{ MHz}, P_{IN} = 0 \text{ dBm}$) | 100 ps |
| Reverse Leakage (both outputs terminated) | -40 dB |
| SSB Phase Noise (100 kHz offset) | -148 dBc/Hz <u>3</u> / |
| 4.4. <u>Radiation Features</u> | |
| Maximum total dose available (dose rate = $50 - 300$ rads (Si)/s). | 100k rads (Si) |
| Single event phenomenon (SEP): | |
| No single event latchup (SEL) occurs at effective linear energy | |
| | |

^{1/} Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions outside of those indicated in the operation sections of this specification is not implied. Exposure to 2/ All typical specifications are at T_A = 25 °C, Vcc = 5 V, unless otherwise noted.

 $^{3/}P_{IN} = 0$ dBm, $F_{IN} = 6$ GHz

^{4/} Limits are characterized at initial qualification and after any design or process changes that may affect the SEP characteristics, but are not production tested unless specified by the customer through purchase order or contract. For more information on single event effect (SEE) test results, customers are requested to contact ADI.

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TABLE I – ELECTRICAL PERFORMANCE CHARACTERISTICS

| Parameter | Cumahad | Conditions <u>1</u> / Unless otherwise specified | | Sub Cusum | Limits | | l luita |
|---------------------------|-----------------|---|--------------------------|-----------|--------|-------|---------|
| See notes at end of table | Symbol | | | Sub-Group | Min | Max | Units |
| RF CHARACTERISTICS | | | | | | | |
| Input Frequency | F _{IN} | | | 4,5,6 | 1 | 12 | GHz |
| | | | M,D,P,L,R | 4 | 1 | 12 | |
| Output Power <u>4</u> / | Pout | F _{IN} = 1 GHz | | 4.6 | 2.5 | | dBm |
| | | $P_{IN} = -15 \text{ dBm}, +10 \text{ dBm}$ | ı | 4,6 | 2.5 | | |
| | | | M,D,P,L,R | 4 | 2.5 | | |
| | | F _{IN} = 1 GHz | | 5 | 2.5 | | |
| | | $P_{IN} = -10 \text{ dBm}, +10 \text{ dBm}$ | | , | 2.5 | | |
| | | $F_{IN} = 4 \text{ GHz}$ | | 4,5,6 | 1 | | |
| | | $P_{IN} = -15 \text{ dBm}, +10 \text{ dBm}$ | | | | | |
| | | 5 0.611 | M,D,P,L,R | 4 | 1 | | |
| | | $F_{IN} = 8 \text{ GHz}$ | | 4,5,6 | 0 | | |
| | | $P_{IN} = -15 \text{ dBm}, +2 \text{ dBm}$ | M,D,P,L,R | 4 | 0 | | |
| | | F _{IN} = 11 GHz | 141,D,F,L,IX | 4,6 | -3.0 | | |
| | | $P_{IN} = -15 \text{ dBm}, 0 \text{ dBm}$ | | 5 | -5.5 | | |
| | | I IN — 13 abili, 0 abili | M,D,P,L,R | 4 | -3.0 | | |
| | | F _{IN} = 12 GHz | 11.,0,1.,0,1. | 4,6 | -5.0 | | |
| | | $P_{IN} = -10 \text{ dBm}, 0 \text{ dBm}$ | | 5 | -6.5 | | |
| | | , | M,D,P,L,R | 4 | -5.0 | | |
| SUPPLY CURRENT | 1 | 1 | | | | | |
| Supply Current | lcc | No RF | | 1,2,3 | | 105 | mA |
| , | | | M,D,P,L,R | 1 | | 105 | |
| Harmonic Content | -1 | | | l. | | | |
| Feedthrough | FTHRU | $P_{IN} = -10 \text{ dBm}, F_{IN} = 6 \text{ G}$ | Hz <u>2</u> / <u>3</u> / | 4,5,6 | | -13.5 | dBm |
| 3 rd harmonic | 3rd | $P_{IN} = -10 \text{ dBm}, F_{IN} = 6.0$ | Hz <u>2</u> / <u>3</u> / | 4,5,6 | | -11 | dBm |

TABLE I NOTES:

^{1/}Vcc = 5 V, TA nom = 25 °C, TA max = 85 °C, and TA min = -40 °C unless otherwise noted.

^{2/} Parameter is part of device initial characterization which is only repeated after design and process changes or with subsequent wafer lots.

^{3/} Parameter is not tested post irradiation

 $[\]underline{4}$ / Apply for both pin 5 and pin 7. Output power is single-ended.

TABLE IIA – ELECTRICAL TEST REQUIREMENTS

| Test Requirements | Subgroups (in accordance with MIL-PRF-38535, Table III) |
|---|---|
| Interim Electrical Parameters | 1,4 |
| Final Electrical Parameters | 1,4 <u>1</u> / <u>2</u> / |
| Group A Test Requirements | 1, 2, 3, 4, 5, 6 |
| Group C end-point electrical parameters | 1, 4 <u>2</u> / |
| Group D end-point electrical parameters | 1,4 |
| Group E end-point electrical parameters | 1,4 <u>3</u> / |

Table IIA Notes:

TABLE IIB - BURN-IN/ LIFE TEST DELTA LIMITS 1/2/

| Parameter | Test Conditions | Symbol | Delta | Units |
|-------------------------|---|--------|-------|-------|
| Supply Current | Vcc = 5.0 V lcc | | ±10 | % |
| | No RF | | | |
| Output Power <u>3</u> / | Vcc = 5.0 V | Pout | ±1 | dB |
| | F _{IN} = 1 GHz, P _{IN} = -15 dBm | | | |
| | $F_{IN} = 1 \text{ GHz}, P_{IN} = +10 \text{ dBm}$ | | | |
| | F _{IN} = 4 GHz, P _{IN} = -15 dBm | | | |
| | $F_{IN} = 4 \text{ GHz}, P_{IN} = +10 \text{ dBm}$ | | | |
| | $F_{IN} = 8 \text{ GHz}, P_{IN} = -15 \text{ dBm}$ | | | |
| | $F_{IN} = 8 \text{ GHz}, P_{IN} = +2 \text{ dBm}$ | | | |
| | $F_{IN} = 11 \text{ GHz}, P_{IN} = -15 \text{ dBm}$ | | | |
| | $F_{IN} = 11 \text{ GHz}, P_{IN} = 0 \text{ dBm}$ | | | |
| | $F_{IN} = 12 \text{ GHz}, P_{IN} = -10 \text{ dBm}$ | | | |
| | $F_{IN} = 12 \text{ GHz}, P_{IN} = 0 \text{ dBm}$ | | | |

^{1/} PDA applies to Table I subgroup 1 and Table IIB delta parameters. 2/ See Table IIB for delta parameters 3/ Parameters noted in Table I are not tested post irradiation.

TABLE IIB Notes: 1/240 hour burn in and 1000 hour life test (Group C) end point electrical parameters. 2/ Deltas are performed at T_A = +25 °C only. 3/ Apply for both pin 5 and pin 7.

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5.0 Burn-In, Life Test, and Radiation

5.1. Burn-In Test Circuit, Life Test Circuit

- 5.1.1.The test conditions and circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 test condition D of MIL –STD-883.
- 5.1.2.HTRB is not applicable for this drawing.

5.2. Radiation Exposure Circuit

5.2.1. The radiation exposure circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing and acquiring activity upon request. Total dose irradiation testing shall be performed in accordance with MIL-STD-883 method 1019, condition A.

6.0 MIL-PRF-38535 QMLV Exceptions

The manufacturing flow described in the RF & MICROWAVE STANDARD SPACE LEVEL PRODUCTS PROGRAM is to be considered a part of this specification. The brochure describes standard QMLV exceptions for Aerospace products run at the ADI Chelmsford, MA facility.

6.1. Wafer Fabrication

Foundry information is available upon request.

6.2. Group D

Group D-5 Salt Atmosphere testing is not performed.

7.0 **Application Notes**

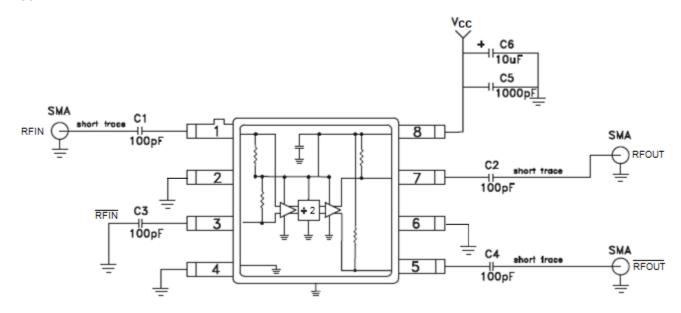


Figure 3 - Application Circuit

8.0 Package Outline Dimensions

The G8 package and outline dimensions can be found at http://www.analog.com or upon request.

ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option |
|--------------|-------------------|---------------------------------|----------------|
| ADH361R701G8 | −40 °C to +85 °C | 8 Lead Glass/Metal Hermetic SMT | G8 (FR-8-2) |

| Revision History | | | | |
|------------------|-----------------------|-----------|--|--|
| Rev | Description of Change | Date | | |
| Α | Initial Release | 9/22/2020 | | |
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